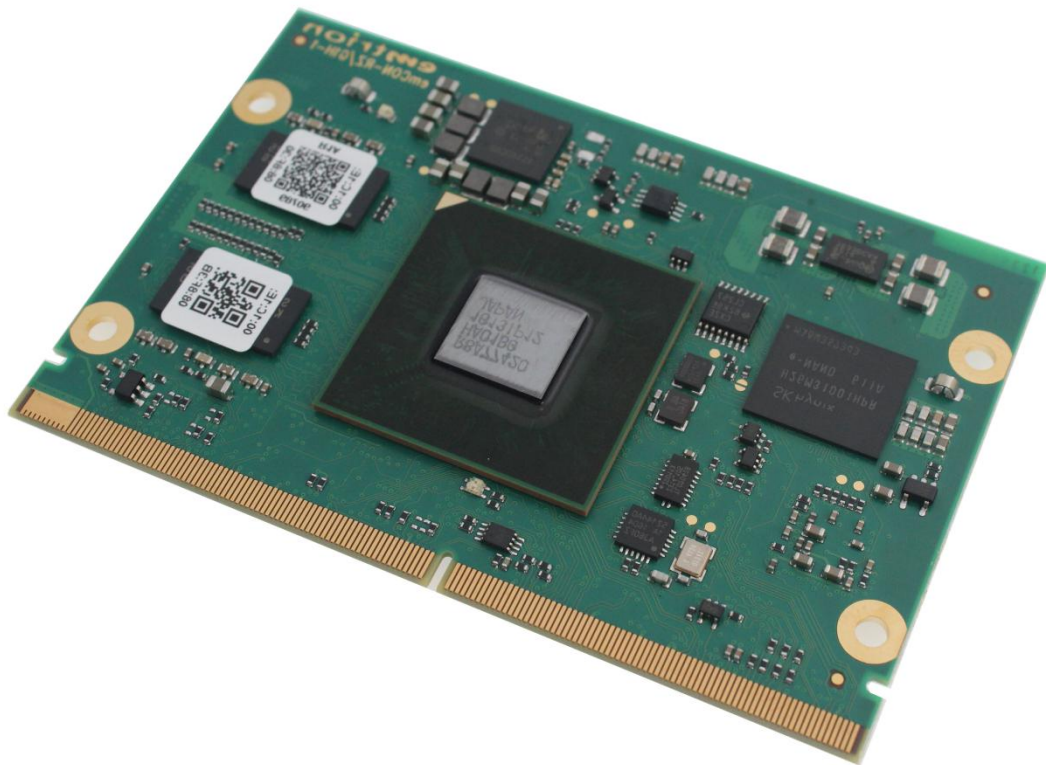


emCON-RZ/G1H - Hardware Manual

Hardware Manual

Rev1 / 14.08.2017



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1 Introduction

The emCON-RZ/G1H module is a CPU board of emtrion's emCON-family based on the RZ/G1H processor from Renesas.

The RZ/G1H is Renesas's top-performing device for general-purpose applications. It is equipped with quad-core Cortex™-A15 (1.4 GHz) and Cortex™-A7 (780 MHz) CPUs. The cores are accompanied by a variety of functions required for rich graphics and industrial applications. These functions include a 3D graphics accelerator, video processing unit, USB3.0 and USB 2.0 controllers, PCIe interface, SATA interface, Gb Ethernet interface, CAN interface and others.

All interfaces are accessible through a 315 pin MXM type III edge connector. The pin assignment is defined by emtrion's emCON standard, which ensures a pin-to-pin compatibility within all emCON CPU modules.

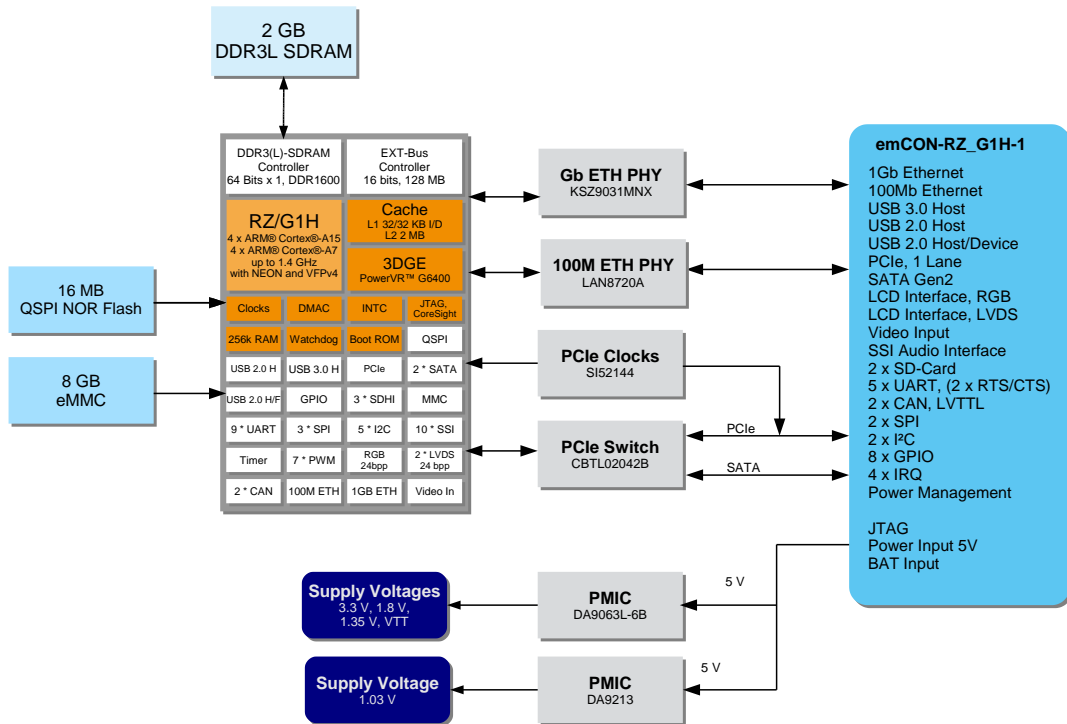
The following table lists the features and interfaces of the emCON-RZ/G1H processor module:

emCON-RZ/G1H
2 GByte DDR3L-1600 RAM
up to 32GB eMMC NAND Flash
PowerVR™ G6400 3D graphics accelerator
1 x 100/1000 Mbit Ethernet, 1 x 100 Mbit Ethernet
1 x USB 3.0 Host
1 x USB 2.0 Host
1 x USB 2.0 Device
1 x PCIe 2.0 (1 lane)
1 x RGB interface, 18bit, max. 1080p (1920x1080)
2 x LVDS interface, 24bit max. 1080p (1920x1080)
1 x Video In, 8 bit
1 x SSI Audio
1 x SATA II
2 x SD Card
2 x CAN (LVTTTL)
5 x UART (LVTTTL)
2 x SPI
2 x I2C
8 x GPIO, 3x PWM
RTC, battery backed
JTAG

The module is available in commercial temperature range 0°C to 70°C and optionally in extended temperature range -40°C to 85°C.

2 Block Diagram

The following figure shows the block diagram of the emCON-RZ/G1H.



3 Handling Precautions

Please read the following notes prior to installing the processor module. They apply to all ESD (electrostatic discharge) sensitive components:

- The module does not need any configurations before installation.
- The module does not provide any on-board ESD protection circuitry – this must be provided by the product it is used in.
- Before installing the module it is recommended that you discharge yourself by touching a grounded object.
- Be sure all tools required for installation are electrostatically discharged as well.
- Before installing (or removing) the module, unplug the power cable from your mains supply.
- Handle the board with care and try to avoid touching its components or tracks.

4 Functional Description

4.1 Processor

The emCON-RZ/G1H module is based on the processor RZ/G1H from Renesas [1]. It is equipped with quad-core Cortex[®]-A15 (1.4 GHz) and Cortex[®]-A7 (780 MHz) CPUs. In addition to the CPU cores with their NEON[™]/VFPv4 extension and L1 and L2 Caches, the processor provides a lot of peripheral functions such as:

- DDR3L-1600 SDRAM controller with 64 bit data bus
- 100/1000 Mb Ethernet MAC
- 100 Mb Ethernet MAC
- Two SERDES interfaces which can be configured as either
 - SATA II interface
 - USB 3.0 Host
 - PCIe interface
- 3 x independent display unit for TFT displays with RGB and LVDS interface; resolutions up to 1080p (1920x1080) @60Hz and 24 bpp are supported
- 3D graphics engine PowerVR Series G6400
- 2D graphics rendering function
- 3 channel video input module
- Video processing unit
- USB 2.0 Host with high-speed mode
- USB 2.0 Function with high-speed mode
- 4 x SD Card Host controller
- Audio interface with I2S format
- 2 x CAN controller
- 9 x UART with up to 128 byte FIFO
- 4 x I2C bus interface
- 2 x SPI interface
- JTAG debug interface

Further details of the processor can be found in the RZ/G1H Reference Manual [1].

4.1.1 Processor Clocks

The processor is clocked by a 20 MHz main clock from a quartz crystal. Three internal PLLs multiply the 20 MHz clock input to the internally needed clocks. The core clock PLL (PLL1) is set to 3.12 GHz, the peripheral PLL (PLL0) is set to 2.6 GHz.

All clocks within the processor are derived from these PLL frequencies, via various software configurable dividers. More information about the RZ/G1H clock system is described in the CPG chapter of the Common RZ/G Series User Manual [1].

4.1.2 Mode Settings

The processor mode is configured by 31 configuration pins that are sampled at the end of reset.

Most of the bits are fixed and cannot be changed by the user.

MD24 is used to configure the PCIEC0 interface as either SATA-1 or PCIe function. This bit can be configured by a soldering bridge.

BR1	Interface PCIEC0
open	PCIe
closed	SATA-1

Watch that changing this configuration demands to change the software accordingly.

4.2 DDR3 SDRAM

The module incorporates either two or four 4-Gbit DDR3L SDRAMs that are addressed as either 32 bits x 1 channel or 64 bits x 1 channel. The resulting total RAM size is either 1 GByte or 2 GByte

The RAMs are clocked with 800 MHz (DDR3-1600 mode).

RAM size	Start address	End address
1GB	0x00 4000 0000	0x00 7FFF FFFF
2GB	0x00 4000 0000	0x00 BFFF FFFF

Please contact emtrion GmbH for your required RAM size.

4.3 NOR-Flash

A 16 MByte QSPI NOR Flash is connected to the QSPI interface of the RZ/G1H processor. This is the standard boot device and cannot be changed.

The clock rate of the interface is limited to 48.75 MHz by the processor.

4.4 eMMC

To store the operating system and application data, normally an 8 GByte eMMC is available on the emCON-RZ/G1H module. It is connected to the MMC interface of the RZ/G1H using 8 data lines.

The signalling level of the MMC interface is sourced by LDOC of the PMIC DA9063L. The default voltage is 3.3 V. It can be changed to 1.8 V by the I²C interface of the PMIC for higher data rates.

The storage capacity of the eMMC can be adapted to customers needs by soldering different chips. Please contact emtrion GmbH for your required eMMC capacity.

4.5 SD-Card Interface

The RZ/G1H includes three SD Card Host interfaces. Two of them (SDHI0 and SDHI2) are connected to the SD Card interfaces SDC1 and SDC2 of the emCON connector.

The signaling voltage of both SD Card interfaces can be switched individually between 1.8 V and 3.3 V by the GPIOs GP5_28 and GP5_29. A low level selects 1.8 V and a high level selects 3.3 V. GP5_28 controls interface SDHI0 and GP5_29 controls interface SDHI2.

Both interfaces can be configured to operate in Default, High Speed and SDR50 mode. Interface SDHI0 is also capable to be operated in SDR104 mode.

Watch that the active high Write Protect inputs of both interfaces are pulled high at the CPU module. The pin must be pulled low externally if a µSD socket is connected since these sockets do not incorporate a write protect switch.

4.6 Ethernet

4.6.1 General

The RZ/G1H processor incorporates two Ethernet interfaces, a 100/1000 MBit Ethernet interface, called Ethernet AVB, and a 10/100 Mbit Ethernet interface, called Ethernet MAC. Both interfaces are available at the emCON connector.

4.6.2 AVB

The Ethernet AVB interface of the RZ/G1H processor is connected to an external PHY KSZ9031MNX from Micrel by a GMII interface. The output signals of the PHY are connected to the GBit Ethernet interface GBE1 of the emCON connector. The PHY address is set to 1.

The LED signals for speed and traffic are connected to the specific pins of the emCON connector. The emCON pin GBE1_LED_10_100# and GBE1_LED_1000# are both connected to the LED1 pin of the Ethernet PHY and light if a link is established. Therefore the link speed has to be determined by software. The emCON pin GBE1_LED_TRAFFIC# is connected to the LED2 pin of the Ethernet PHY and indicates if data is transferred ("blinking light" = traffic).

An appropriate 1:1 transformer with 100nF capacitors to GND at each center tap pin must be added externally. The center tap pin must not be supplied with 3.3 VDC!

4.6.3 MAC

The Ethernet MAC interface of the RZ/G1H processor is connected to an external PHY LAN8720A from Microchip by an RMII interface. The output signals of the PHY are connected to the lower data pairs of the GBE2 interface of the emCON connector. The PHY address is set to 1.

The LAN8720A is operated in REFCLK_IN mode. A 50 MHz clock from a crystal oscillator is connected to the PHY and the ETH_REFCLK input of the MAC inside the RZ/G1H.

The LED signals for speed and traffic are connected to specific pins of the GBE2 interface of the emCON connector.

4.7 SATA, PCIe, USB3.0

The RZ/G1H processor incorporates two SERDES physical interfaces that can be configured to operate as SATA, PCIe or USB3.0 interface. Interface 0 can be configured as SATA-0 or USB3.0. Interface 1 can be configured as SATA-1 or PCIe. The configuration is done by the mode pins MD23 and MD24 after reset.

At the emCON-RZ/G1H module the interface PCIEC0 is configured to operate as USB3.0 interface. The signals are routed to the USB3.0 super speed pins of the USB Host interface of the emCON connector.

The configuration of interface PCIEC1 is selectable by the solder bride BR1 to be configured as PCIe interface or as SATA-1 interface. The SERDES signals are connected with the emCON connector by a PCIe multiplexer/demultiplexer CBTL02042A from NXP to either the SATA or the PCIe lane 1 interface.

The soldering bridge has the following meaning:

BR1	Interface PCIEC0
open	PCIe
closed	SATA-1

The signal PCIE_DISABLE# is not driven by the board. The pin is left open. The signal PCIE_RST# is driven by the GPIO pin GP1_22 of the RZ/G1H processor.

All PCIe clock lines are driven by a quad channel clock synthesizer SI52144 from Silicon Labs. The default settings of the chip cannot be changed by software.

No AC coupling capacitors are fit in the signal paths of the PCIe interface. They must be populated externally on a connected module. The transmit signal pair of the USB3.0 interface and both signal pairs of the SATA interface have AC coupling capacitors populated.

4.8 USB 2.0

4.8.1 General

The RZ/G1H processor incorporates two USB 2.0 Host interfaces USB1 and USB2 and a USB 2.0 Host/Function interface USB0. The interface USB0 is connected to the USB 2.0 OTG port of the emCON connector. The interface USB2 is connected to the USB 2.0 Host interface of the emCON connector. USB1 is unused.

4.8.2 USB0

The interface USB0 is not a true USB OTG interface but can be operated as either Host or Function. The Host/Function selection is done by the USB_ID signal of the emCON connector.

The signal USB_ID signal can be read by GPIO GP5_20 of the processor. USB_ID is low when either the Host interface is selected by the emCON connector or if the USB0 interface is configured as Host and the USB0_PWEN output is driven high.

The pin USB0_OVC_VBUS of the processor (GP5_19) signals either the level of the overcurrent input USBOTG_OC# or the level of the signal USBOTG_VBUS at the emCON connector. The input is automatically selected by the Host/Device selection signal USBOTG_ID. The following truth table shows the behavior of the USB interface:

USB_ID at emCON	USB0_PWEN	Comment
Low	x	Host selected, GP5_19 is overcurrent input
High/Open	0	Function selected, GP5_19 is VBUS input
x	1	Host selected, GP5_19 is overcurrent input

4.8.3 USB2

The interface USB2 is connected to the USB 2.0 pins of the USB Host interface.

The pin GP5_22 of the RZ/G1H processor is used as active high USB Host Power Enable output. The signal is inverted and connected to the active low signal USBH_PEN# of the emCON interface.

The pin GP5_23 is the corresponding overcurrent input of the USB Host interface. This signal is also active low.

4.9 Graphic Display Interfaces

4.9.1 General

Three independently controllable display units (DUs) are available at the RZ/G1H processor. They can drive two LVDs interfaces with 4 lanes each and an RGB24 interface. DU0 can either drive the RGB24 interface or the LVDS0 interface. DU1 can either drive the RGB24 interface or the LVDS1 interface. DU2 can either drive the RGB24 interface or the LVDS1 interface.

Typically DU0 and DU1 drive the LVDS interfaces and DU2 drives the RGB interface.

The maximum resolution of all display units is 1080 x 1920 pixels which is FullHD. The maximum frame rate at FullHD resolution is limited to 55 Hz due to the usage of internal clocks.

All display units can either display the same image or fully independent images.

4.9.2 LVDS Interfaces

The LVDS0 interface of the RZ/G1H processor is connected to the LVDS1 channel of the emCON connector. The LVDS1 interface is connected to the LVDS2 channel of the emCON connector.

The backlight control signal LVDS1_BL_CTRL is driven by the pin PWM5 of the RZ/G1H processor. The pins LVDS1_BL_EN and LVDS1_PANEL_EN are not driven by the processor and pulled low by 2K2 resistors.

The following table summarizes the signals of the two LVDS interfaces:

Signal	Description
LVDS1_CLK_P/N	Differential LVDS clock pair
LVDS1_CH[3:0]_P/N	4 differential LVDS data pairs
LVDS1_PANEL_EN	PD 2k2
LVDS1_BL_EN	PD 2k2
LVDS1_BL_CTRL	PWM signal to control the backlight, PWM5
LVDS2_CLK_P/N	Differential LVDS clock pair
LVDS2_CH[3:0]_P/N	4 differential LVDS data pairs

The colour and control signal mapping to the LVDS signal pairs can be selected from 8 different modes. Typically Mode 0 is set, which results in following mapping:

Signal	Slot0	Slot1	Slot2	Slot3	Slot4	Slot5	Slot6
LVDS_CH0	G2	R7	R6	R5	R4	R3	R2
LVDS_CH1	B3	B2	G7	G6	G5	G4	G3
LVDS_CH2	DE	VS	HS	B7	B6	B5	B4
LVDS_CH3	CTL	B1	B0	G1	G0	R1	R0

Further information on colour mapping can be found in [1].

4.9.3 RGB Interface

The RGB interface of RZ/G1H processor is connected to the RGB interface of the emCON connector. Only the upper 18 colour bits of the processor are used and connected to the lower 18 bits of the emCON interface.

The signal LCD_BL_CTRL of the emCON connector is driven by the signal PWM4 of the processor. The power control signal LCD_BL_EN is driven by GPIO GP4_28. The signal LCD_PANEL_EN is driven by GPIO pin GP4_29.

The following table summarizes the used data and control lines.

Signal	Description
LCD_D[17:0]	18 bit colour data
LCD_PCLK	Pixel clock

LCD_HSYNC	Horizontal synchronization signal
LCD_DE	Data enable signal
LCD_VSYNC	Vertical synchronization signal
LCD_PANEL_EN	Display power enable signal, GP4_29
LCD_BL_EN	Backlight power enable signal, GP4_28
LCD_BL_CTRL	PWM signal to control the backlight, PWM4

The following table shows the RGB colour mapping of the pins LCD_D[23:0] at the emCON connector.

LCD_D[23:0]	RGB666 (18 bit)
LCD_D0	B2
LCD_D1	B3
LCD_D2	B4
LCD_D3	B5
LCD_D4	B6
LCD_D5	B7
LCD_D6	G2
LCD_D7	G3
LCD_D8	G4
LCD_D9	G5
LCD_D10	G6
LCD_D11	G7
LCD_D12	R2
LCD_D13	R3
LCD_D14	R4
LCD_D15	R5
LCD_D16	R6
LCD_D17	R7
LCD_D18	n/c
LCD_D19	n/c
LCD_D20	n/c
LCD_D21	n/c
LCD_D22	n/c
LCD_D23	n/c

4.10 Video Input

The emCON-RZ/G1H processor incorporates four video input units which can be used with different video sources, such as video CODECs or CMOS camera modules.

Only the interface VIN3 of the RZ/G1H processor is connected as 8-bit parallel interface to the CPI1 interface pins of the emCON connector. The serial MIPI interface CSI2 of the emCON connector is unused.

4.11 Audio Interface

The audio interfaces SSI7 and SSI8 of the RZ/G1H processor are connected to the I2S audio interface pins of the emCON connector. SSI7 is the output channel, SSI8 is the input channel. Both

channels share their word select and clock signals so that they must be operated with identical data format and clock rate.

An external audio CODEC with I2S interface can directly be connected to the interface pins.

Since the audio interface clocks are derived from the internal processor clock M2φ with 195 MHz they do not fit perfectly to the needed audio frequencies. For example the frequency error at 44.1 kHz sample rate is 0.13%. To get exact audio frequencies an external audio clock source can be connected to the emCON pin I2S_MCLK which is connected to the pin AUDIO_CLKB of the RZ/G1H processor.

4.12 Serial Ports

The emCON-RZ/G1H processor incorporates a couple of serial ports with different characteristics. At the emCON connector five UART interfaces are available; two of them incorporate modem control lines.

The serial interfaces SCIFA0_B, SCIFA1_B, SCIFA2_C, SCIFB2 and HSCIF1 of the RZ/G1H processor are connected to the emCON connector. The following table shows the usage of the UART interfaces:

RZ/G1H peripheral	emCON interface	Modem Control
SCIFA1	UART_A	RTS/CTS
SCIFB2	UART_B	RTS/CTS
HSCIF1	UART_C	not available
SCIFA2	UART_D	not available
SCIFA0	UART_E	not available

SCIFA1 at UARTA is used as standard debug and console interface (Terminal).

4.13 I²C Interfaces

The RZ/G1H processor incorporates six I²C interfaces.

The interfaces I2C0 and I2C2 of the processor RZ/G1H are connected to the interfaces I2C1 and I2C2 of the emCON connector. The interface I2C3 is used on board to connect the PMICs to the processor.

The internally used I2C components on the module have the following characteristics:

Function	Device	Interface	High Level	I ² C Address (7bit)
PMIC1	DA9063L	I2C3	1.8 V	0x5A
PMIC2	DA9213-A	I2C3	1.8 V	0x60

The interfaces at the emCON connector operate with 400 kHz clock and have 2K2 pull-up resistors to 3.3 V.

4.14 SPI Interfaces

The RZ/G1H processor incorporates three SPI interfaces.

The interface MSIOF1 of the RZ/G1H processor is connected to the SPI1 interface of the emCON connector. The interface MSIOF2 is connected to the SPI2 interface.

Both SPI interface have CS1# and CS2# connected to MSIOFx_SS1# and MSIOFx_SS2#.

4.15 CAN

The RZ/G1H processor incorporates two CAN controllers, which comply with the ISO11898-1 specification. The CAN protocol specification 2.0B, with standard and extended message frames, is supported. The maximum baud rate is 1Mbps.

The TX and RX signals of both interfaces are routed to the emCON connector as LVTTTL signals.

The interface CAN0_B of the processor is connected to the interface CAN1 of the emCON connector. The interface CAN1_B is connected to the interface CAN2.

CAN transceivers must be added externally.

4.16 General Purpose I/Os

The emCON interface provides eight dedicated GPIO pins which are directly connected to the RZ/G1H processor. The following table shows the signal connections:

emCON Signal	RZ/G1H Pin	Direction
GPIO_1	GP1_0	In/Out
GPIO_2	GP1_1	In/Out
GPIO_3	GP1_2	In/Out
GPIO_4	GP1_3	In/Out
GPIO_5	GP1_10	In/Out
GPIO_6	GP1_11	In/Out
GPIO_7	GP1_13	In/Out
GPIO_8	GP1_14	In/Out

All signals have LVTTTL level and can drive up to +/-4 mA when configured as output.

4.17 PWM

The RZ/G1H processor incorporates seven PWM timers. Three of them are directly connected to the emCON connector:

emCON Signal	PWM Channel	Usage
PWM_FAN	PWM3	Fan speed control
LCD_BL_CTRL	PWM4	Backlight dimming
LVDS1_BL_CTRL	PWM5	Backlight dimming

The signal level of each PWM pin is 3.3V. The output drive strength is +/-8 mA.

4.18 RTC

Watch that an RTC is not populated at Rev 1 boards!

To enable time keeping while the module is powered off a RTC xxx is fit. The RTC is connected to I²C interface I2C2 of the RZ/G1H processor. The 7-bit I²C address of the RTC is xxx.

To keep the RTC running a voltage of minimum 1.5 V must be sourced at pin VBAT of the emCON connector. The battery current consumption of the RTC is below 0.5 μ A.

4.19 Status LED

A bicolour LED is connected to the pins GP4_0 and GP4_1 of the RZ/G1H processor. If only GP4_0 is high the LED is lighting green, if only GP4-1 is high the LED is lighting red. If both pins are high the LED is lighting yellow.

An additional, green LED shows that the 3.3V supply is on.

4.20 Interrupts

The RZ/G1H processor has an integrated interrupt controller that analyzes all interrupt sources, prioritizes them and outputs the interrupt with the highest priority to the CPU core. The interrupts can be configured to be edge triggered on rising or falling edge or to be level sensitive on high or low level.

The emCON connector specifies six interrupt inputs. Two of them are reserved for touch interface controllers. Three inputs are generous interrupt inputs. The last interrupt input is provided as power fail input.

The following table shows the interrupt connections of the emCON connector:

emCON Signal	RZ/G1H Pin
IRQ_TOUCH1#	GP5_24
IRQ_TOUCH2#	GP5_25
IRQ_1	GP5_26
IRQ_2	GP5_27
IRQ_3	-
POWERFAIL#	NMI

Additionally the PMICs drive in parallel the RZ/G1H interrupt pin IRQ2 locally on the module.

The interrupt inputs at the emCON connector are pulled high by 10 k Ω resistors.

4.21 Reset

There are several ways to cause a power reset of the board:

- one of the on board supply voltages fails
- the signal RESI# of the emCON connector is driven low
- the signal JTAG_RESI# of the emCON connector is driven low
- setting the SHUTDOWN bit in the PMIC DA9063L
- clearing the bit RESOUT in register RSTOUTCR of the processor RZ/G1H

- expiration of the watchdog timer

All resets cause hardware resets of the whole board.

The duration of the reset signal is min. 200 ms. To reset external devices the reset signal is driven to pin RESO# of the emCON connector.

4.22 Power Supply

The power consumption of the module is **1.5 A – 3 A** at +5V, +/- 5%. The current consumption depends on the software running.

All supply voltages that are needed for the processor and the other components are generated on board by the two Power Management Chips DA9063L and DA9213-A from Dialog Semiconductor.

The output voltages of the PMICs can be configured via the I²C interface I2C3. The 7-bit I²C address of the PMIC DA9063L is 0x5A, the 7-bit I²C address of the PMIC DA9213-A is 0x60.

4.22.1 Power Management Signals

VCC_5V, VCC_STANDBY

VCC_5V is the main supply input for the module. To keep only parts of the PMIC alive in power down states a second supply VCC_STANDBY is provided. This voltage supplies parts of the PMIC DA9063L with minimum current consumption.

The output signal SUSPEND# of the emCON connector is provided to switch off the main supply VCC_5V in power down states. The switch must be realized on the carrier board. If no power management is needed, VCC_STANDBY and VCC_5V can be connected together.

POWER_ON_BASE

If the 3.3 V supply of the CPU module is switched off by power management, it must be ensured that no external peripherals with 3.3 V interface is driving input pins any longer. Otherwise unintended current flow might happen across the data lines.

The signal POWER_ON_BASE is provided to switch off external components with 3.3 V supply. The signal is high while the 3.3 V supply on the module is active. Otherwise the signal is low. The power switch must be realized on the carrier board.

POWERFAIL#

The signal POWERFAIL# is an input to signalize a power fail condition. The signal is connected to the NMI input of the RZ/G1H processor.

ON_OFF#

The signal ON-OFF# can be used to switch the PMIC into power down mode and back to normal operating mode. This pin must be driven by an open collector circuit.

BAT

The pin BAT at the emCON connector is used as battery input for the RTC's backup power supply. The typical power consumption of the RTC at the BAT pin is < 0.5 μ A.

5 emCON Interface

All interface signals of the board are available at the emCON connector.

The emCON interface is a 314 pos MXM connector. These sockets are available from various manufacturers.

The pin assignment is emtrion specific and match for the most needs of interfaces for actual embedded designs. Depending on the features of the CPUs every emtrion CPU module will use a subset of the emCON connector. More details can be found in emtrion's emCON specification.

Usage details of the connector and its electrical and mechanical characteristics can be found further down in this document.

Notes:

The pin assignment of the emCON connector is ONLY compatible with devices of emtrion's emCON-family. Insertion into a socket with another pin assignment may damage the emCON-RZ/G1H module and the carrier board.

Most of the pins are directly connected with the processor RZ/G1Hx.

6 Pin Assignments

6.1 J1, emCON Connector

Type MXM, 314 pos

Compatible carrier board connector: Aces 91782-3140M-001

Pin	Signal	Interface		Signal	Pin
1E20	GND	Power Supply		VCC_5V	2E20
1E19	GND			VCC_5V	2E19
1E18	GND			VCC_5V	2E18
1E17	GND			VCC_5V	2E17
1E16	GND			VCC_5V	2E16
1E15	GND			VCC_5V	2E15
1E14	GND			VCC_5V	2E14
1E13	GND			VCC_5V	2E13
1E12	GND			VCC_5V	2E12
1E11	GND			VCC_5V	2E11
1E10	BAT	Manufacturing		VCC_STANDBY	2E10
1E9	n/c			n/c	2E9
1E8	n/c			POWER_ON_BASE	2E8
1E7	n/c			GP5_24	2E7
1E6	RESET_IN#			GP5_25	2E6
1E5	n/c			GP5_26	2E5
1E4	JTAG_TRST#			GP5_27	2E4
1E3	JTAG_TMS			n/c	2E3
1E2	JTAG_TDO			RESO#	2E2
1E1	JTAG_TDI			RESET_IN#	40
1	JTAG TCK	MISC		POWERFAIL#	2
3	1.8 V JTAG_VCC			SUSPEND#	4
5	JTAG_TCK			ON_OFF#	6
7	GND			n/c	8
9	SCIFA1_RXD			PWM3	10
11	SCIFA1_TXD			GND	12
13	SCIFA1_RTS			HRXD1	14
15	SCIFA1_CTS			HTXD1	16
17	SCIFB2_RXD			SCIFA2_RXD	18
19	SCIFB2_TXD			SCIFA2_TXD	20
21	SCIFB2_RTS	SCIFA0_RXD	22		
23	SCIFB2_CTS	SCIFA0_TXD	24		
25	GND	POWER		GND	26
27	GPIO1_0	GPIOs		n/c	28
29	GPIO1_1			GP1_22	30
31	GPIO1_2			PCIE_CLK_P	32
33	GPIO1_3			PCIE_CLK_N	34
35	GPIO1_10			GND	36
37	GPIO1_11			PCIE_RX1_P	38
		UART-A		POWER	
		UART-B		UART-C	
		UART-C		UART-D	
		UART-D		UART-E	
		UART-E			

39	GPIO1_13			PCIE_RX1_N	40	
41	GPIO1_14			PCIE_TX1_P	42	
43	GND	POWER		PCIE_TX1_N	44	
45	n/c	RGB IF		GND	46	
47	n/c			n/c	48	
49	n/c			n/c	50	
51	n/c			n/c	52	
53	n/c			n/c	54	
55	n/c			GND	56	
57	LCD_D17			n/c	58	
59	LCD_D16			n/c	60	
61	LCD_D15			GND	62	
63	LCD_D14			n/c	64	
65	LCD_D13			n/c	66	
67	LCD_D12			n/c	68	
69	GND			n/c	70	
71	LCD_D11			GND	72	
73	LCD_D10			n/c	74	
75	LCD_D9			n/c	76	
77	LCD_D8			n/c	78	
79	LCD_D7			n/c	80	
81	LCD_D6			POWER	GND	82
83	LCD_D5			RFU	n/c	84
85	LCD_D4				n/c	86
87	LCD_D3			CPI2 Camera	n/c	88
89	LCD_D2				n/c	90
91	LCD_D1				n/c	92
93	LCD_D0	n/c	94			
95	LCD_DOTCLK	n/c	96			
97	LCD_HSYNC	n/c	98			
99	LCD_VSYNC	n/c	100			
101	LCD_DE	n/c	102			
103	PWM4	n/c	104			
105	GP4_28	n/c	106			
107	GP4_29	n/c	108			
109	CAN1_RX	CAN2	CAN1	CAN0_RX	110	
111	CAN1_TX			CAN0_TX	112	
113	GND	POWER	POWER	GND	114	
115	MSIOF1_SCK	SPI 1	SPI 2	MSIOF2_CS1#	116	
117	MSIOF1_SS1#			MSIOF2_CS0#	118	
119	MSIOF1_MOSI			MSIOF2_MOSI	120	
121	MSIOF1_MISO			MSIOF2_MISO	122	
123	MSIOF1_SS2#			MSIOF2_SCK	124	
125	n/c					
The pins 126 - 132 are used for mechanical coding and not available as electrical pins						
133	VIN3_D0	VIN3 Camera	MIPI_CSI2	n/c	134	

135	VIN3_D1		Camera	n/c	136
137	VIN3_D2			n/c	138
139	VIN3_D3			n/c	140
141	VIN3_D4			n/c	142
143	VIN3_D5			n/c	144
145	VIN3_D6			n/c	146
147	VIN3_D7			n/c	148
149	VIN3_CLK			n/c	150
151	VIN3_HSYNC			n/c	152
153	VIN3_VSYNC		POWER	GND	154
155	GND	POWER		SCL0	156
157	PWM5		I2C1	SDA0	158
159	pd	LVDS1 Control		SCL2	160
161	pd		I2C2	SDA2	162
163	GND	POWER		LVDS1_D0_P	164
165	LVDS0_D0_P			LVDS1_D0_N	166
167	LVDS0_D0_N			LVDS1_D1_P	168
169	LVDS0_D1_P			LVDS1_D1_N	170
171	LVDS0_D1_N			LVDS1_D2_P	172
173	LVDS0_D2_P			LVDS1_D2_N	174
175	LVDS0_D2_N			LVDS1_D3_P	176
177	LVDS0_D3_P			LVDS1_D3_N	178
179	LVDS0_D3_N			LVDS1_CLK_P	180
181	LVDS0_CLK_P			LVDS1_CLK_N	182
183	LVDS0_CLK_N		POWER	GND	184
185	GND	POWER		n/c	186
187	n/c			n/c	188
189	n/c	SPDIF		n/c	190
191	SSI_D8			n/c	192
193	SSI_D7			n/c	194
195	SSI_WS78			n/c	196
197	SSI_SCK78			n/c	198
199	SSI_WS78			n/c	200
201	SSI_SCK78			GND	202
203	ACLK			n/c	204
205	SATA_RX_P			n/c	206
207	SATA_RX_N			n/c	208
209	SATA_TX_P			n/c	210
211	SATA_TX_N			GND	212
213	GND	POWER		GND	214
215	USBOTG_ID			USB2_DP	216
217	USB0_DP			USB2_DN	218
219	USB0_DN			n/c	220
221	USB0_VBUS			USB2_OC#	222
223	USB0_OC#			USB2_PEN#	224
225	USB0_PEN#			USBH_SSRX_P	226
		USB OTG	USB Host		
			USB3.0		

227	n/c			USBH_SSRX_N	228	
229	n/c		POWER	GND	230	
231	GND	POWER	USB3.0	USBH_SSTX_P	232	
233	n/c			USBH_SSTX_N	234	
235	n/c		POWER	GND	236	
237	GND	POWER	SD Card 1	SD2_CLK	238	
239	SD0_CLK			SD2_CMD	240	
241	SD0_CMD			SD2_D0	242	
243	SD0_D0			SD2_D1	244	
245	SD0_D1			SD2_D2	246	
247	SD0_D2			SD2_D3	248	
249	SD0_D3			SD2_CD#	250	
251	SD0_CD#			SD2_WP	252	
253	SD0_WP			POWER	GND	254
255	GND	POWER		Ethernet2	n/c	256
257	GBE1_MDIO_P		n/c		258	
259	GBE1_MDIO_N		n/c		260	
261	GBE1_MD11_P		n/c		262	
263	GBE1_MD11_N		ETH_RXN		264	
265	GBE1_MD12_P		ETH_RXP		266	
267	GBE1_MD12_N		ETH_TXN		268	
269	GBE1_MD13_P		ETH_TXP		270	
271	GBE1_MD13_N		POWER		GND	272
273	GND	POWER			LED_100M#	274
275	GBE_1_LED_LAN#		Ethernet2	n/c	276	
277	GBE_1_LED_LAN#	Ethernet1		LED_TRA#	278	
279	GBE_1_TRAFFIC#			n/c	280	
281	n/c					

7 Signal Characteristics

Abbreviations:

AI analogue input
 AO analogue output
 A I/O analogue bidirectional
 I digital input
 O digital output
 I/O digital bidirectional
 O(OD) digital open drain output

PU xK x K Ω pullup resistor
 PD xK x K Ω pulldown resistor
 SR xR x Ω series resistor
 IPU xK processor internal x K Ω pullup resistor
 IPD xK transistor internal x K Ω pulldown resistor
 SC x x Farad series capacitor

7.1 J1, emCON Connector

Name	RZ/G1H Pin	GPIO	Direction	Termination	Volt	Max. Current	Description
Gigabit Ethernet 1							
GBE1_MDIO_P	-	-	A I/O	-	-	N/A	GBE diff. data pair 0
GBE1_MDIO_N	-	-	A I/O	-	-	N/A	
GBE1_MDI1_P	-	-	A I/O	-	-	N/A	GBE diff. data pair 1
GBE1_MDI1_N	-	-	A I/O	-	-	N/A	
GBE1_MDI2_P	-	-	A I/O	-	-	N/A	GBE diff. data pair 2

GBE1_MDI2_N	-	-	A I/O	-	-	N/A	GBE diff. data pair 3
GBE1_MDI3_P	-	-	A I/O	-	-	N/A	
GBE1_MDI3_N	-	-	A I/O	-	-	N/A	
GBE1_LED_1000#	-	-	O	-	3.3V	20mA	Speed indication (GBE1_LED_1000# and GBE1_LED_10_100# are shorted)
GBE1_LED_10_100#	-	-	O	-	3.3V	20mA	Speed indication (GBE1_LED_1000# and GBE1_LED_10_100# are shorted)
GBE1_LED_TRAFFIC#	-	-	O	-	3.3V	20mA	Traffic indication

Ethernet 2

ETH_TXP	-	-	A I/O	-	-	N/A	ETH diff. transmit pair 0
ETH_TXN	-	-	A I/O	-	-	N/A	
ETH_RXP	-	-	A I/O	-	-	N/A	ETH diff. receive pair 1
ETH_RXN	-	-	A I/O	-	-	N/A	
GBE1_LED_10_100#	-	-	O	-	3.3V	20mA	10/100M# Speed indication
GBE1_LED_TRAFFIC#	-	-	O	-	3.3V	20mA	Traffic indication

USB Host

USBH_SSRX_P	AL27	-	I	-	SSTL	N/A	USB 3.0 super speed pair
USBH_SSRX_N	AL28	-	I	-	SSTL	N/A	
USBH_SSTX_P	AL29	-	O	SC 100n	SSTL	N/A	USB 3.0 super speed pair
USBH_SSTX_N	AL30	-	O	SC 100n	SSTL	N/A	
USBH_PEN#	#AD30	GP5_22	O	-	3.3V	32mA	USB power enable
USBH_OC#	AC30	GP5_23	I	-	3.3V	N/A	USB overcurrent signal from power switch
USBH_DP	AK31	-	I/O	-	-	N/A	USB 2.0 diff. data pair
USBH_DM	AJ31	-	I/O	-	-	N/A	

USB OTG							
USBOTG_ID	AC29	GP5_20	I	PU 10K	3.3V	N/A	USB ID signal for OTG functionality
USBOTG_PEN#	AC28	GP5_18	O	-	3.3V	16mA	Host: USB power
USBOTG_OC#	AD28	GP5_19	I	PU 10K	3.3V	N/A	Host: USB overcurrent
USBOTG_VBUS	AD28	GP5_19	I	PD 32K	4.2V – 5.5V	N/A	Device: VBUS
USBOTG_DP	AF31	-	I/O	-	-	N/A	USB 2.0 diff. data pair
USBOTG_DM	AE31	-	I/O	-	-	N/A	

SATA							
SATA_TXP	AL25	-	A O	SC 12n	SSTL	N/A	SATA diff. data pair
SATA_TXN	AL26	-	A O	SC 12n	SSTL	N/A	
SATA_RXP	AL23	-	A I	SC 12n	SSTL	N/A	SATA diff. data pair
SATA_RXN	AL24	-	A I	SC 12n	SSTL	N/A	

PCIe							
PCIE_RXP	AL25	-	A I	-	SSTL	4mA	PCIe diff. data pair
PCIE_RXM	AL26	-	A I	-	SSTL	4mA	
PCIE_TXP	AL23	-	A O	-	SSTL	4mA	PCIe diff. data pair
PCIE_TXM	AL24	-	A O	-	SSTL	4mA	
CLK1_P	-	-	A O	-	SSTL	4mA	PCIe diff. clock pair
CLK1_N	-	-	A O	-	SSTL	4mA	
PCIE_RESET#	AH2	GP1_22	O	PD 10K	3.3V	4mA	Reset output for PCIe

UART							
UART-A_TXD	AH5	GP0_21	O	PU 10K	3.3V	8mA	UART transmit data
UART-A_RXD	AL5	GP0_24	I	-	3.3V	N/A	UART receive data
UART-A_RTS	AJ5	GP0_22	O	-	3.3V	8mA	UART modem control
UART-A_CTS	AJ4	GP0_25	I	-	3.3V	N/A	UART modem control
UART-B_TXD	T28	GP4_23	O	PU 10K	3.3V	8mA	UART transmit data

UART-B_RXD	T26	GP4_22	I	-	3.3V	N/A	UART receive data
UART-B_RTS	V31	GP4_25	O	-	3.3V	8mA	UART modem control
UART-B_CTS	R25	GP4_24	I	-	3.3V	N/A	UART modem control
UART-C_TXD	AE5	GP1_18	O	-	3.3V	4mA	UART transmit data
UART-C_RXD	AC1	GP1_12	I	-	3.3V	N/A	UART receive data
UART-D_TXD	AK11	GP5_30	O	PU 10K	3.3V	4mA	UART transmit data
UART-D_RXD	AJ11	GP5_31	I	-	3.3V	N/A	UART receive data
UART-E_TXD	AH1	GP1_21	O	-	3.3V	4mA	UART transmit data
UART-E_RXD	AD2	GP1_20	I	-	3.3V	N/A	UART receive data

CAN

CAN1_TX	P30	GP4_4	O	-	3.3V	8mA	CAN transmit data
CAN1_RX	P29	GP4_5	I	PU 10K	3.3V	N/A	CAN receive data
CAN2_TX	P27	GP4_6	O	-	3.3V	8mA	CAN transmit data
CAN2_RX	R26	GP4_7	I	PU 10K	3.3V	N/A	CAN receive data

LCD (RGB Display)

LCD_PIXCLK	Y25	GP5_2	O	-	3.3V	8mA	LCD dot clock
LCD_DISP	W26	GP5_16	O	-	3.3V	8mA	LCD data enable signal
LCD_VSYNC	U30	GP4_15	O	-	3.3V	8mA	LCD frame sync
LCD_HSYNC	U31	GP4_14	O	-	3.3V	8mA	LCD line sync
LCD_D0	V26	GP5_8	O	-	3.3V	8mA	LCD B2
LCD_D1	V27	GP5_9	O	-	3.3V	8mA	LCD B3
LCD_D2	U26	GP5_10	O	-	3.3V	8mA	LCD B4
LCD_D3	U25	GP5_11	O	-	3.3V	8mA	LCD B5
LCD_D4	Y31	GP5_12	O	-	3.3V	8mA	LCD B6
LCD_D5	V25	GP5_13	O	-	3.3V	8mA	LCD B7
LCD_D6	AA30	GP4_27	O	-	3.3V	8mA	LCD G2

LCD_D7	W25	GP4_30	O	-	3.3V	8mA	LCD G3
LCD_D8	V28	GP5_7	O	-	3.3V	8mA	LCD G4
LCD_D9	W28	GP5_14	O	-	3.3V	8mA	LCD G5
LCD_D10	W29	GP5_15	O	-	3.3V	8mA	LCD G6
LCD_D11	AB28	GP5_4	O	-	3.3V	8mA	LCD G7
LCD_D12	P26	GP4_16	O	-	3.3V	8mA	LCD R2
LCD_D13	U29	GP4_17	O	-	3.3V	8mA	LCD R3
LCD_D14	U27	GP4_18	O	-	3.3V	8mA	LCD R4
LCD_D15	T25	GP4_19	O	-	3.3V	8mA	LCD R5
LCD_D16	V29	GP4_20	O	-	3.3V	8mA	LCD R6
LCD_D17	U28	GP4_21	O	-	3.3V	8mA	LCD R7
LCD_PANEL_EN	Y30	GP4_29	O	-	3.3V	8mA	LCD panel power enable
LCD_BL_EN	AA29	GP4_28	O	-	3.3V	8mA	LCD backlight power enable
LCD_BL_CTRL	AG6	PWM4	O	-	3.3V	8mA	LCD backlight brightness control

LVDS 1

LVDS1_CLK_P	AG17	-	O	-	1,8V	N/A	LVDS diff clock pair
LVDS1_CLK_N	AG18	-	O	-	1,8V	N/A	
LVDS1_TX0_P	AJ18	-	O	-	1,8V	N/A	LVDS diff data pair
LVDS1_TX0_N	AJ19	-	O	-	1,8V	N/A	
LVDS1_TX1_P	AG19	-	O	-	1,8V	N/A	LVDS diff data pair
LVDS1_TX1_N	AG20	-	O	-	1,8V	N/A	
LVDS1_TX2_P	AL18	-	O	-	1,8V	N/A	LVDS diff data pair
LVDS1_TX2_N	AL17	-	O	-	1,8V	N/A	
LVDS1_TX3_P	AJ17	-	O	-	1,8V	N/A	LVDS diff data pair
LVDS1_TX3_N	AJ16	-	O	-	1,8V	N/A	
LVDS1_PANEL_EN	-	-	O	PD 2K2	3.3V	4mA	LVDS panel power enable
LVDS1_BL_EN	-	-	O	PD 2K2	3.3V	4mA	LVDS backlight power enable
LVDS1_BL_CTRL	AH6	PWM5	O	-	3.3V	8mA	LVDS backlight brightness control

LVDS 2							
LVDS2_CLK_P	AL19	-	O	-	1,8V	N/A	LVDS diff clock pair
LVDS2_CLK_N	AL20	-	O	-	1,8V	N/A	
LVDS2_TX0_P	AJ23	-	O	-	1,8V	N/A	LVDS diff data pair
LVDS2_TX0_N	AJ22	-	O	-	1,8V	N/A	
LVDS2_TX1_P	AL21	-	O	-	1,8V	N/A	LVDS diff data pair
LVDS2_TX1_N	AL22	-	O	-	1,8V	N/A	
LVDS2_TX2_P	AJ20	-	O	-	1,8V	N/A	LVDS diff data pair
LVDS2_TX2_N	AJ21	-	O	-	1,8V	N/A	
LVDS2_TX3_P	AG22	-	O	-	1,8V	N/A	LVDS diff data pair
LVDS2_TX3_N	AG21	-	O	-	1,8V	N/A	

CPI1 (Camera Input)							
VIN3_D0	AF9	GP0_0	I	-	3.3V	8mA	Video image input data
VIN3_D1	AG9	GP0_1	I	-	3.3V	8mA	Video image input data
VIN3_D2	AH9	GP0_2	I	-	3.3V	8mA	Video image input data
VIN3_D3	AJ9	GP0_3	I	-	3.3V	8mA	Video image input data
VIN3_D4	AK9	GP0_4	I	-	3.3V	8mA	Video image input data
VIN3_D5	AL9	GP0_5	I	-	3.3V	8mA	Video image input data
CPI2_D6	AF8	GP0_6	I	-	3.3V	8mA	Video image input data
VIN3_D7	AG8	GP0_7	I	-	3.3V	8mA	Video image input data
VIN3_PIXCLK	AK1	GP1_23	I	-	3.3V	8mA	Video clock
VIN3_HSYNC	AE3	GP1_16	I	-	3.3V	8mA	Video line sync
VIN3_VSYNC	AE4	GP1_17	I	-	3.3V	4mA	Video frame sync

SD Card Interface 1							
SDC1_D0	W2	GP3_2	I/O	PU 47K	1.8V/3.3V	16mA	SDC data
SDC1_D1	V7	GP3_3	I/O	PU 47K	1.8V/3.3V	16mA	SDC data
SDC1_D2	V6	GP3_4	I/O	PU 47K	1.8V/3.3V	16mA	SDC data
SDC1_D3	V5	GP3_5	I/O	PU 47K	1.8V/3.3V	16mA	SDC data

SDC1_CMD	V4	GP3_1	I/O	PU 47K	1.8V/3.3V	16mA	CMD signal
SDC1_CLK	V1	GP3_0	O	SR 22R	1.8V/3.3V	16mA	SDC clock
SDC1_CD#	W3	GP3_6	I	PU 10K	3.3V	N/A	Card detect
SDC1_WP	W4	GP3_7	I	PD 10K	3.3V	N/A	Write protect

SD Card Interface 2

SDC2_D0	R5	GP3_18	I/O	PU 47K	1.8V/3.3V	16mA	SDC data
SDC2_D1	R4	GP3_19	I/O	PU 47K	1.8V/3.3V	16mA	SDC data
SDC2_D2	R3	GP3_20	I/O	PU 47K	1.8V/3.3V	16mA	SDC data
SDC2_D3	T5	GP3_21	I/O	PU 47K	1.8V/3.3V	16mA	SDC data
SDC2_CMD	T4	GP3_17	I/O	PU 47K	1.8V/3.3V	16mA	CMD signal
SDC2_CLK	R1	GP3_16	O	SR 22R	1.8V/3.3V	16mA	SDC clock
SDC2_CD#	T2	GP3_22	I	PU 10K	3.3V	N/A	Card detect
SDC2_WP	T3	GP3_23	I	PD 10K	3.3V	N/A	Write protect

SPI1

SPI1_SS0#	R27	GP4_10	O		3.3V	8mA	SPI slave select
SPI1_SS1#	T31	GP4_11	O		3.3V	8mA	SPI slave select
SPI1_SCK	R31	GP4_8	O		3.3V	8mA	SPI clock
SPI1_MISO	R29	GP4_13	I		3.3V	8mA	SPI data from slave
SPI1_MOSI	T29	GP4_12	O		3.3V	8mA	SPI data to slave

SPI2

SPI2_SS0#	AL2	GP0_30	O		3.3V	8mA	SPI slave select
SPI2_SS1#	AH3	GP0_31	O		3.3V	8mA	SPI slave select
SPI2_SCK	AL4	GP0_27	O		3.3V	8mA	SPI clock
SPI2_MISO	AL3	GP0_29	I		3.3V	8mA	SPI data from slave
SPI2_MOSI	AK3	GP0_28	O		3.3V	8mA	SPI data to slave

I2C1

I2C1_SCL	AG15	-	I/O	PU 2K2	3.3V	15mA	I ² C clock
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I2C1_SDA	AF15	-	I/O (OD)	PU 2K2	3.3V	15mA	I ² C data
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I2C2

I2C2_SCL	AC27	GP5_5	I/O	PU 2K2	3.3V	8mA	I ² C clock
I2C2_SDA	AB27	GP5_6	I/O (OD)	PU 2K2	3.3V	8mA	I ² C data

Audio SSI

AUDIO_RXD	AD4	GP1_27	I		3.3V	N/A	Audio input data
AUDIO_TXD	AD5	GP1_26	O		3.3V	4mA	Audio output data
AUDIO_TXC	AC5	GP1_24	I/O		3.3V	4mA	Audio transmit bit clock
AUDIO_TXFS	AC6	GP1_25	I/O		3.3V	4mA	Audio transmit frame select
AUDIO_RXC	AC5	GP1_24	I/O		3.3V	4mA	Audio receive bit clock
AUDIO_RXFS	AC6	GP1_25	I/O		3.3V	4mA	Audio receive frame select
ACLK	W31	GP4_26	I		3.3V	N/A	Audio master clock

General Purpose I/O

GPIO1	AG1	GP1_0	I/O		3.3V	8mA	digital input / output
GPIO2	AG2	GP1_1	I/O		3.3V	8mA	digital input / output
GPIO3	AG3	GP1_2	I/O		3.3V	8mA	digital input / output
GPIO4	AG4	GP1_3	I/O		3.3V	8mA	digital input / output
GPIO5	AD1	GP1_10	I/O		3.3V	8mA	digital input / output
GPIO6	AJ2	GP1_11	I/O		3.3V	8mA	digital input / output
GPIO7	AC2	GP1_13	I/O		3.3V	8mA	digital input / output
GPIO8	AC3	GP1_14	I/O		3.3V	8mA	digital output only

Manufacturing

JTAG_TCK	AE14		I	PU 10K	1.8V	N/A	JTAG clock (JTAG_TCK and JTAG_RTCK are shorted)
JTAG_TMS	AF14		I	PU 10K	1.8V	N/A	JTAG mode select
JTAG_TRST#	AG16		I	PD 1K	1.8V	N/A	JTAG test reset
JTAG_TDI	AH14		I	PU 10K	1.8V	N/A	JTAG data input
JTAG_TDO	AH12		O		1.8V	1mA	JTAG data output

JTAG_RTCK	AE18		O	PU 10K	1.8V	N/A	JTAG return clock (JTAG_TCK and JTAG_RTCK are shorted)
JTAG_MOD	-	-	-	-	-	-	Mode selection JTAG/Boundary Scan
JTAG_RESET#	-	-	-	-	1.8V	N/A	JTAG reset
JTAG_VCC					1.8V		JTAG voltage reference

Miscellaneous

IRQ_1	AJ13	GP5_26	I	PU 10K	3.3V	N/A	Interrupt input
IRQ_2	AH13	GP5_27	I	PU 10K	3.3V	N/A	Interrupt input
IRQ_3	-	-	-	-	-	-	Interrupt input
IRQ_TOUCH1#	AA25	GP5_24	I	PU 10K	3.3V	N/A	Interrupt input for touch controller
IRQ_TOUCH2#	AB26	GP5_25	I	PU 10K	3.3V	N/A	Interrupt input for touch controller
POWERFAIL#	AG12	NMI	I	PD 20K	5V	N/A	Power Fail interrupt
PWM_FAN	AL7	PWM3	O		3.3V	8mA	PWM signal for fan control
RESI#			I	PU 10K	3.3V	N/A	Reset input from carrier board
RESO#			O		3.3V	20mA	Reset output to carrier board
POWER_ON_BASE			O		3.3V	20mA	Power enable signal for the 3.3V baseboard supply
SUSPEND#			O		3.3V	20mA	Power switching signal for VCC_5V
ON_OFF#			I	PU 100K	5V	N/A	Power management signal

Power Supply

BAT			-	-	2.0V – 3.3V	N/A	Battery backup supply for RTC
VCC_5V			-	-	-	N/A	+ 5V supply
VCC_STANDBY			-	-	-	N/A	+ 5V standby supply
GND			-	-	-	N/A	Ground

8 Technical Characteristics

8.1 Electrical Specifications

Supply voltage	5V, +/-5%
Current consumption	up to 4 A

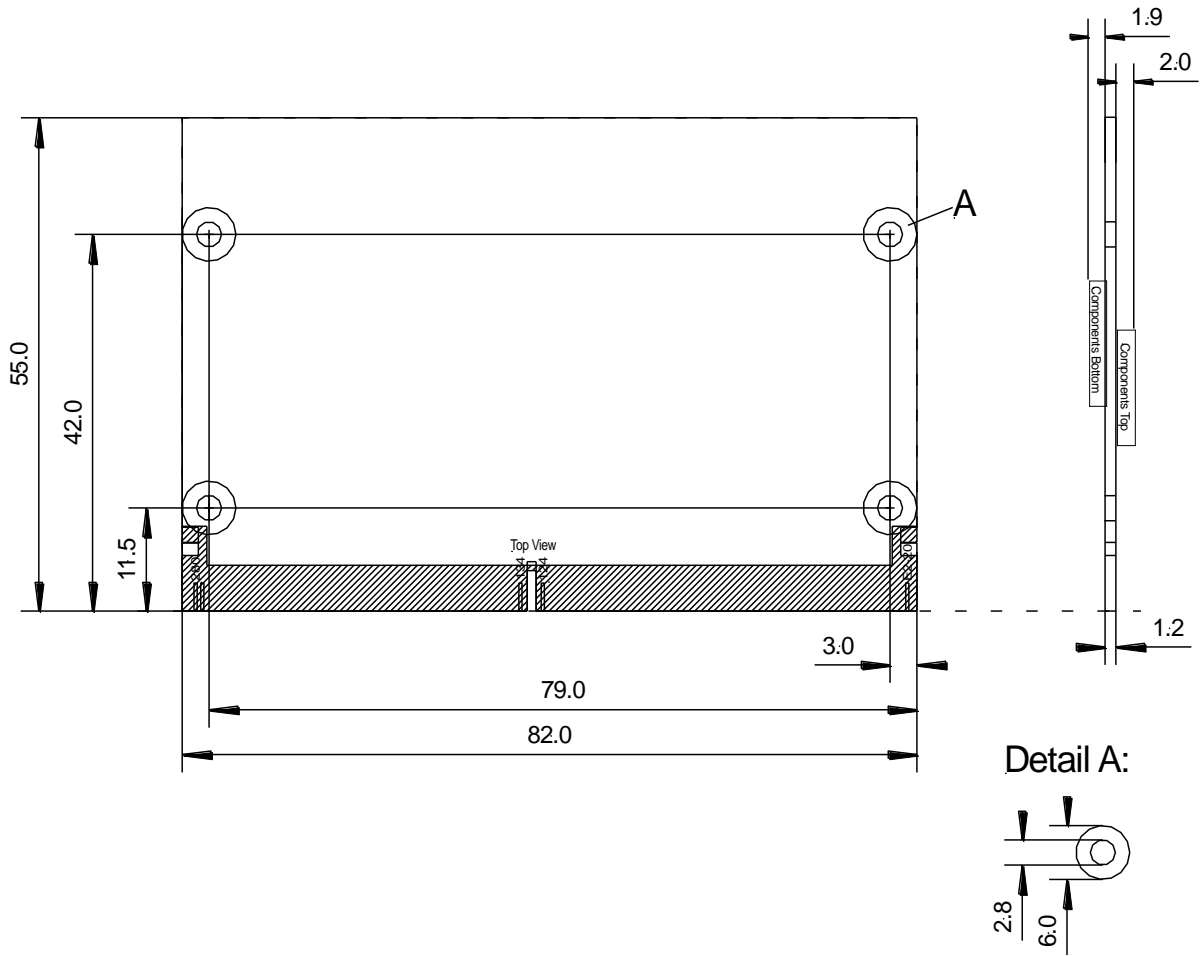
8.2 Environmental Specifications

Operating temperature	
Standard:	0 ... +70°C
Extended:	-40 ... +85°C
Storage temperature	-40 ... +125°C
Relative humidity	0 ... 95 %, non-condensing

8.3 Mechanical Specifications

Weight	approx. 19 g
Board	Glasepoxi FR-4, UL-listed, 10 layers
Dimensions	82.2 mm x 55.0 mm x 5.0 mm

9 Dimensional Drawing



10 References

- [1] RZ/G Series
User's Manual: Hardware
Specifications Common to RZ/G Series Products
R01UH0543EJ0050 Rev.0.50, Oct 30,2015
Renesas

- [2] RZ/G1H
User's Manual: Hardware
Specifications of Individual RZ/G Series Product
R01UH0626EJ0050 Rev.0.50, Oct 30,2015
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